

1 **IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

2 InventorshipLees et al.
3 Applicant Microsoft Corporation
4 Attorney's Docket No. MS1-677US
5 Title: Linked Value Replication

6 **DECLARATION FOR PATENT APPLICATION**

7 As a below named inventor, I hereby declare that:

8 My residence, post office address and citizenship are as stated below next to
9 my name.

10 I believe I am the original, first and sole inventor (if only one name is listed
11 below) or an original, first and joint inventor (if plural names are listed below) of the
12 subject matter which is claimed and for which a patent is sought on the invention
13 entitled "Linked Value Replication," the specification of which is attached hereto.

14 I have reviewed and understand the content of the above-identified
15 specification, including the claims.

16 I hereby claim benefit under 35 U.S.C. 119(e) of United States Provisional
17 Application 60/212,950, filed June 21, 2000.

18 I acknowledge the duty to disclose information which is material to the
19 examination of this application in accordance with Title 37, Code of Federal
20 Regulations, § 1.56(a).

21 PRIOR FOREIGN APPLICATIONS: no applications for foreign patents or
22 inventor's certificates have been filed prior to the date of execution of this
23 declaration.

24 **Power of Attorney**

25 I appoint the following attorneys to prosecute this application and transact all
 future business in the Patent and Trademark Office connected with this application:

09554.0190
T06T10"2465460

Lewis C. Lee, Reg. No. 34,656; Daniel L. Hayes, Reg. No. 34,618; Allan T. Sponseller, Reg. 38,318; Steven R. Sponseller, Reg. No. 39,384; James R. Banowsky, Reg. No. 37,773; Lance R. Sadler, Reg. No. 38,605; Michael A. Proksch, Reg. No. 43,021; Thomas A. Jolly, Reg. No. 39,241; David A. Morasch, Reg. No. 42,905; Kasey C. Christie, Reg. No. 40,559; Nathan R. Rieth, Reg. No. 44,302; Brian G. Hart, Reg. No. 44,421; Katie E. Sako, Reg. No. 32,628 and Daniel D. Crouse, Reg. No. 32,022.

Send correspondence to: LEE & HAYES, PLLC, 421 W. Riverside Avenue, Suite 500, Spokane, Washington, 99201. Direct telephone calls to: David A. Morasch (509) 324-9256.

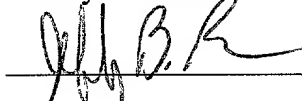
All statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statement may jeopardize the validity of the application or any patent issued therefrom.

Full name of inventor:	William B. Lees
Inventor's Signature	<u>William Lees</u> Date: <u>01/18/01</u>
Residence:	Redmond, WA
Citizenship:	USA
Post Office Address:	14111 NE 85th Ct. Redmond, WA 98052

Full name of inventor:

Jeffrey B. Parham

Inventor's Signature



Date: 1/18/2001

Residence:

Redmond, WA

Citizenship:

USA

Post Office Address:

24015 NE 45th St.
Redmond, WA 98053

Full name of inventor:

Mark R. Brown

Inventor's Signature



Date: 1/18/2001

Residence:

Seattle, WA

Citizenship:

USA

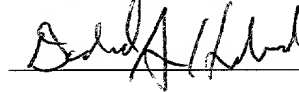
Post Office Address:

516 Malden Ave. E
Seattle, WA 98112

Full name of inventor:

Donald J. Hacherl

Inventor's Signature



Date: 1/18/2001

Residence:

North Bend, WA

Citizenship:

USA

Post Office Address:

45668 SE 129 St.
North Bend, WA 98045

09594-0100
FOI b7c b7d